

N Semiconductor® FAN7080-GF085 Half Bridge Gate Driver

Features

- Automotive Qualified to AEC Q100
- Floating Channel for Bootstrap Operation to +600 V
- Tolerance to Negative Transient Voltage on VS Pin
- VS-pin dv/dt Immune
- Gate Drive Supply Range from 5.5 V to 20 V
- Under-Voltage Lockout (UVLO)
- CMOS Schmitt-triggered Inputs with Pull-down
- High Side Output In-phase with Input
- IN input is 3.3 V/5 V Logic Compatible and Available on 15 V Input
- Matched Propagation Delay for both Channels
- Dead Time Adjustable

Applications

- Junction Box
- Half and full bridge application in the motor drive system Related Product Resources

Description

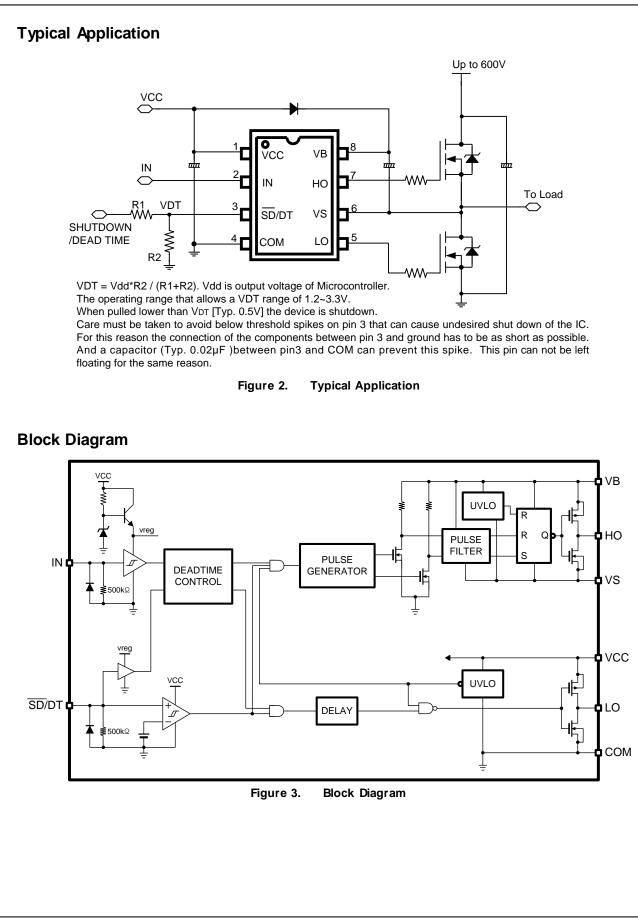
The FAN7080-GF085 is a half-bridge gate drive IC with reset input and adjustable dead time control. It is designed for high voltage and high speed driving of MOSFET or IGBT, which operates up to 600 V. ON Semiconductor's high-voltage process and commonmode noise cancellation technique provide stable operation in the high side driver under high-dV/dt noise circumstances. An advanced level-shift circuit allows high-side gate driver operation up to V_S=-5 V (typical) at V_{BS}=15 V. Logic input is compatible with standard CMOS outputs. The UVLO circuits for both channels prevent from malfunction when V_{CC} and V_{BS} are low er than the specified threshold voltage. Combined pin function for dead time adjustment and reset shutdown make this IC packaged with space saving SOIC-8 Package. Minimum source and sink current capability of output driver is 250 mA and 500 mA respectively, which is suitable for junction box application and half and full bridge application in the motor drive system.



Figure 1. 8-Lead, SOIC, Narrow Body

Part Number	Operating Temperature Range	Package	Packing Method				
FAN7080M-GF085		8-Lead, Small Outline Integrated Circuit (SOIC),	Tube				
FAN7080MX- GF085		JEDEC MS-012, .150 inch Narrow Body	Tape & Reel				

Ordering Information



Pin Configuration

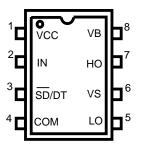


Figure 4. Pin Assignment (Top Through View)

Pin Descriptions

Pin #	Name	I/O	Pin Function Description
1	Vcc	Р	Driver Supply Voltage
2	IN	Ι	Logic input for high and low side gate drive output
3	/SD/DT	I	Shutdow n Input and dead time setting
4	COM	Р	Ground
5	LO	А	Low side gate drive output for MOSFET Gate connection
6	Vs	А	High side floating offset for MOSFET Source connection
7	HO	А	High side drive output for MOSFET Gate connection
8	VB	Р	Driver Output Stage Supply

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
Vs	High-Side Floating Offset Voltage	V _B -25	V _B +0.3	V
VB	High-Side Floating Supply Voltage	-0.3	625	V
V _{HO}	High-Side Floating Output Voltage	V _S -0.3	V _B +0.3	V
V _{LO}	Low-Side Floating Output Voltage	-0.3	V _{cc} +0.3	V
Vcc	Supply Voltage	-0.3	25	V
VIN	Input Voltage for IN	-0.3	V _{CC} +0.3	V
l _{IN}	Input Injection Current (1)		+1	mA
PD	Pow er Dissipation ^(2.3)		0.625	W
θ」Α	Thermal Resistance, Junction to Ambient (2)		200	°C/W
TJ	Junction Temperature		150	°C
T _{STG}	Storage Temperature	-55	150	°C
ESD	Human Body Model (HBM)		1000	V
ESD	Charge Device Model (CDM)		500	v

Notes:

- 1. Guaranteed by design. Full function, no latchup. Tested at 10 V and 17 V.
- The Thermal Resistance and power dissipation rating are measured per below conditions: JESD51-2: Integral circuits thermal test method environmental conditions, natural convection/Still Air JESD51-3: Low effective thermal conductivity test board for leaded surface-mount packages.
- 3. Do not exceed power dissipation (P_b) under any circumstances.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance. ON Semiconductor does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V _B ⁽⁴⁾	High-Side Floating Supply Voltage (DC) Transient: -10 V at 0.1 μ S	Vs+6	V _S +20	V
Vs	High-Side Floating Supply Offset Voltage (DC) Transient: -25 V(max.) at 0.1 μ S at V _{BS} < 25 V		600	V
V _{HO}	High-Side Output Voltage	Vs	VB	V
V _{LO}	Low - Side Output Voltage	0	Vcc	V
Vcc	Supply Voltage for Logic Input	5.5	20	V
VIN	Logic Input Voltage	0	Vcc	V
dv/dt	Allow able Offset Voltage Slew Rate ⁽⁵⁾		50	V/nS
T _{PULSE}	Minimum Pulse Width ^(5,6)	1100		nS
Fs	Sw itching Frequency ⁽⁶⁾		200	KHz
TA	Operating Ambient Temperature	-40	125	°C

Notes:

4. The Vs offset is tested with all supplies based at 15 V differential

5. Guaranteed by design.

6. When $V_{DT} = 1.2$ V. Refer to Figures 5, 6, 7 and 8.

Electrical Characteristics

Unless otherwise specified -40°C \leq T_A \leq 125°C, V_{CC} = 15 V, V_{BS}=15 V, V_S = 0 V, C_L =1 nF

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V _{CC} and V	BS Supply Characteristics					<u> </u>
V _{CCUV+} V _{BSUV+}	V _{CC} and V _{BS} Supply Under-Voltage Positive going Threshold			4.2	5.5	V
V _{CCUV-} V _{BSUV-}	V_{CC} and V_{BS} Supply Under-Voltage Negative going Threshold		2.8	3.6		V
V _{CCUVH} V _{BSUVH}	V _{CC} and V _{BS} Supply Under-Voltage Hysteresis		0.2	0.6		V
t _{DUVCC} t _{DUVBS}	Under-Voltage Lockout Response Time	$V_{CC}: 6 \lor \rightarrow 2.5 \lor \text{ or } 2.5 \lor \rightarrow 6 \lor$ $V_{BS}: 6 \lor \rightarrow 2.5 \lor \text{ or } 2.5 \lor \rightarrow 6 \lor$	0.5 0.5		20 20	μs
ILK	Offset Supply Leakage Current	$V_{\rm B} = V_{\rm S} = 600 \ {\rm V}$		20	50	μA
I Q _{BS}	Quiescent V _{BS} Supply Current	V _{IN} = 0 or 5 V, V _{SDT} = 1.2 V	20	75	150	μA
IQ _{CC}	Quiescent V _{CC} Supply Current	$VI_{N} = 0 \text{ or } 5 \text{ V}, \text{ V}_{SDT} = 1.2 \text{ V}$		350	1000	μA
Input Cha	aracteristics					<u> </u>
VIH	High Logic level Input Voltage		2.7			V
VIL	Low Logic Level Input Voltage				0.8	V
I _{IN+}	Logic Input High Bias Current	V _{IN} = 5 V		10	50	μA
I _{IN-}	Logic Input Low Bias Current	V _{IN} = 0 V		0	2	μA
V _{DT}	V _{DT} Dead Time Setting Range		1.2		5.0	V
V _{SD}	V _{SD} Shutdow n Threshold Voltage			0.8	1.2	V
R _{SDT}	High Logic Level Resistance for /SD /DT	V _{SDT} = 5 V	100	500	1100	kΩ
ISDT-	Low Logic Level Input bias Current for /SD /DT	V _{SDT} = 0 V		1	2	μΑ
Output Cl	haracteristics	1				<u> </u>
V _{OH(HO)}	High Level Output Voltage (V _{CC} - V _{HO})	l _O = 0			0.1	V
V _{OL(HO)}	Low Level Output Voltage (V _{HO})	l _O = 0			0.1	V
I _{O+(HO)}	Output High, Short-Circuit Pulse Current		250	300		mA
Ю-(HO)	Output Low, Short-Circuit Pulse Current		500	600		mA
Rop(ho)	Equivalent Output Resistance				60	
R _{ON(HO)}					30	Ω
V _{OH(LO)}	High Level Output Voltage ($V_B - V_{LO}$)	lo = 0			0.1	V
V _{OL(LO)}	Low Level Output Voltage (V_{LO})	l _O = 0			0.1	V
I _{O+(LO)}	Output High, Short-Circuit Pulse Current		250			mA
lo-(lo)	Output Low, Short-Circuit Pulse Current		500			mA
R _{OP(LO)}	Equivalent Output Resistance				60	0
Ron(lo)	Lyunalent Output Nesistance				30	Ω

Dynamic Electrical Characteristics

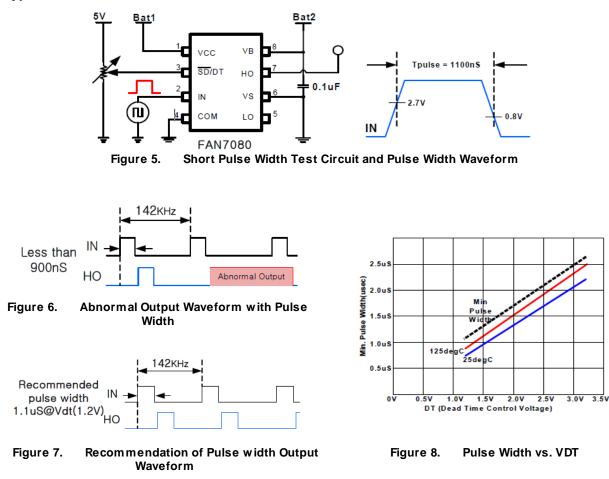
Unless otherwise specified -40°C ≤ T_A ≤ 125°C, V_{CC} = 15 V, V_{BS} =15 V, V_S = 0 V, C_L =1 nF

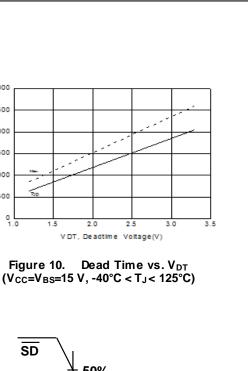
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ton	Turn-On Propagation Delay ⁽⁷⁾	V _S =0 V		750	1500	ns
toff	Turn-Off Propagation Delay	V _S =0 V		130	250	ns
t _R	Turn-On Rise Time			40	150	ns
tF	Turn-Off Fall Time			25	400	ns
Dī	Dead Time, LS Turn-off to HS Turn-on and HS Turn-on to LS Turn-off	$V_{IN} = 0 \text{ or } 5 \text{ V at } VDT = 1.2 \text{ V}$	250	650	1200	ns
DI		$V_{IN} = 0 \text{ or } 5 \text{ V at } VDT = 1.2 \text{ V}$	1600	2100	2600	
Мрт	Dead Time Matching Time	DT1 – DT2 at VDT = 1.2 V		35	110	ns
IVIDT Dead	eau nine Matching nine	DT1 - DT2 at VDT = 3.3 V			300	115
M _{TON}	Delay Matching, HS and LS Turn-on	VDT = 1.2 V		25	110	ns
MTOFF	Delay Matching, HS and LS Turn-off	VDT = 1.2 V		15	60	ns
t _{SD}	Shutdow n Propagation Delay			180	330	ns
F _S 1	Switching Frequency	$V_{CC} = V_{BS} = 20 V$			200	Khz
Fs2	Switching riequency	$V_{CC} = V_{BS} = 5.5 V$			200	

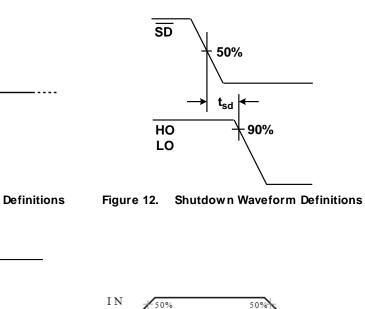
Notes:

7. ton includes DT

Typical Waveforms







3000

2500

2000

1500 1000

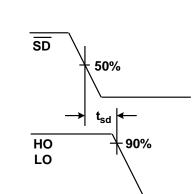
500

0 L 1.0

1.5

2.0

Dead Time(ns)





Input/Output Timing Diagram

90%

109

90%

10%

Typical Performance Characteristics

IN

но

LO

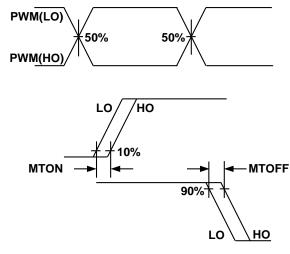
LO

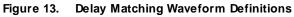
HO

Note: not drawn to scale

Figure 9.

SD/DT





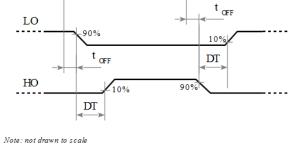


Figure 14. **Dead Time Waveform Definitions**

FAN7080-GF085 — Half Bridge Gate Driver

Typical Performance Characteristics

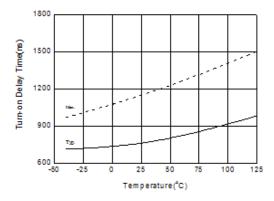


Figure 15. Turn-on Delay Time of HO vs. Temperature ($V_{CC}=V_{BS}=15 V$, $C_{L}=1 nF$)

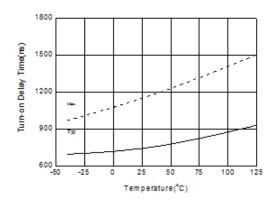
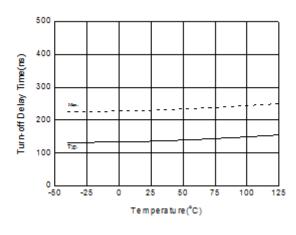
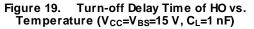


Figure 17. Turn-on Delay Time of LO vs. Temperature ($V_{CC}=V_{BS}=15 V$, $C_L=1 nF$)





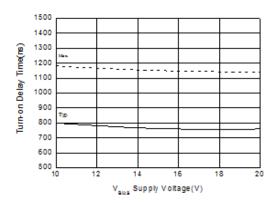


Figure 16. Turn-on Delay Time of HO vs. V_{BS} Supply Voltage (V_{CC}=15 V, C_L=1 nF, T_A=25°C)

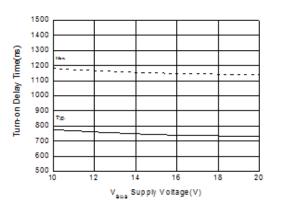
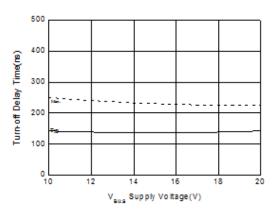
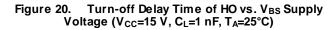
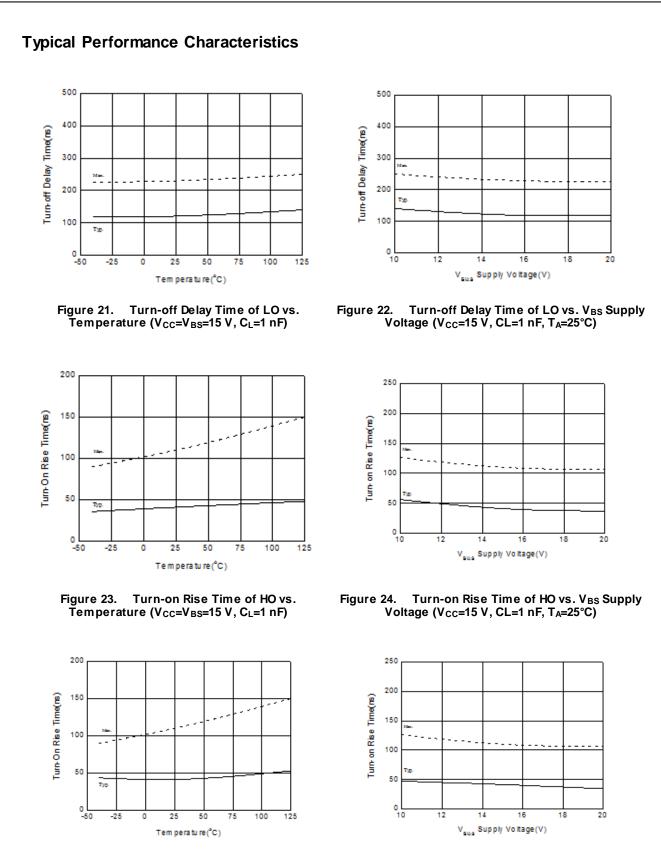


Figure 18. Turn-on Delay Time of LO vs. V_{BS} Supply Voltage (V_{CC}=15 V, C_L=1 nF, T_A=25°C)







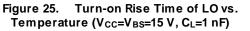


Figure 26. Turn-on Rise Time of LO vs. V_{BS} Supply Voltage (V_{CC}=15 V, C_L=1 nF, T_A=25°C) **Typical Performance Characteristics** 250 150 200 Turn-Off Fall Time(ns) Turn-Off Fall Time(ns) 100 150 100 50 50 тур. 0 0 10 12 14 16 18 20 -50 -25 0 25 50 75 100 125 V Supply Voltage(V) Tem perature(°C) Figure 27. Turn-off Fall Time of HO vs. Figure 28. Turn-off Fall Time of HO vs. V_{BS} Supply Temperature (V_{CC}=V_{BS}=15 V, C_L=1 nF) Voltage (V_{CC}=15 V, C_L=1 nF, T_A=25°C) 150 250 200 Turn-Off Fall Time(ns) Turn-Off Fall Time(ns) 100 150 100 50 50 тур 0 0 L -50 20 100 10 18 -25 0 25 50 75 125 12 14 16 V_{BIOS} Supply Voltage(V) Tem perature(°C) Figure 29. Turn-off Fall Time of LO vs. Figure 30. Turn-off Fall Time of LO vs. Temperature (V_{CC}=V_{BS}=15 V, C_L=1 nF) Temperature (V_{CC}=V_{BS}=15 V, C_L=1 nF) 5 5 4 4 Input Voltage(V) Input Voltage(V) 3 3 Ma. Min. - - -- - -- - -. . . 2 2 1 1 0 L -50 -25 0 25 50 75 100 125 50 125 -25 25 75 100 0 Temperature (°C) Temperature (°C)

Figure 32. Logic High Input Voltage vs. Temperature

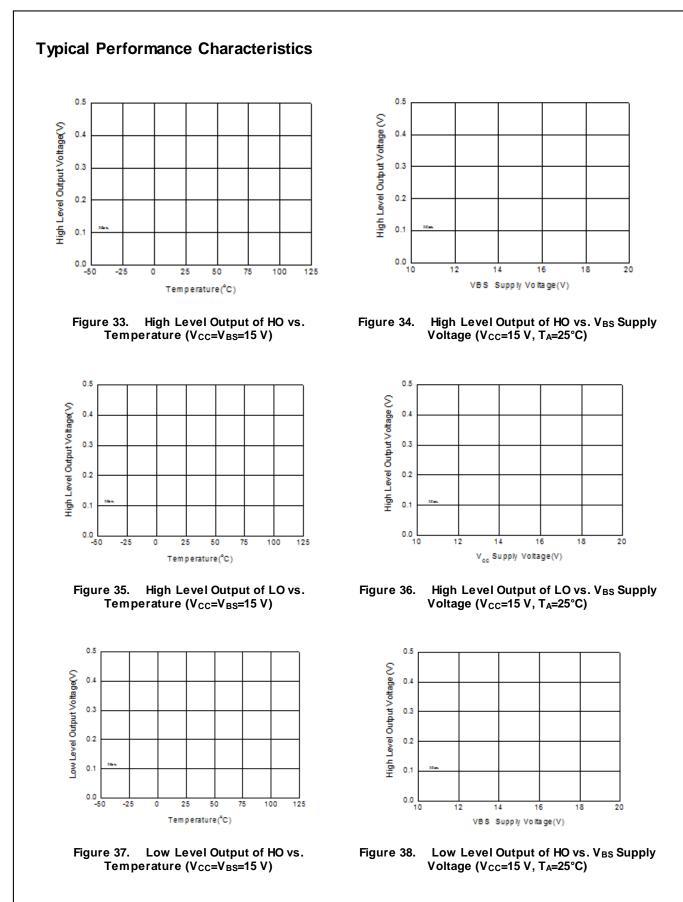
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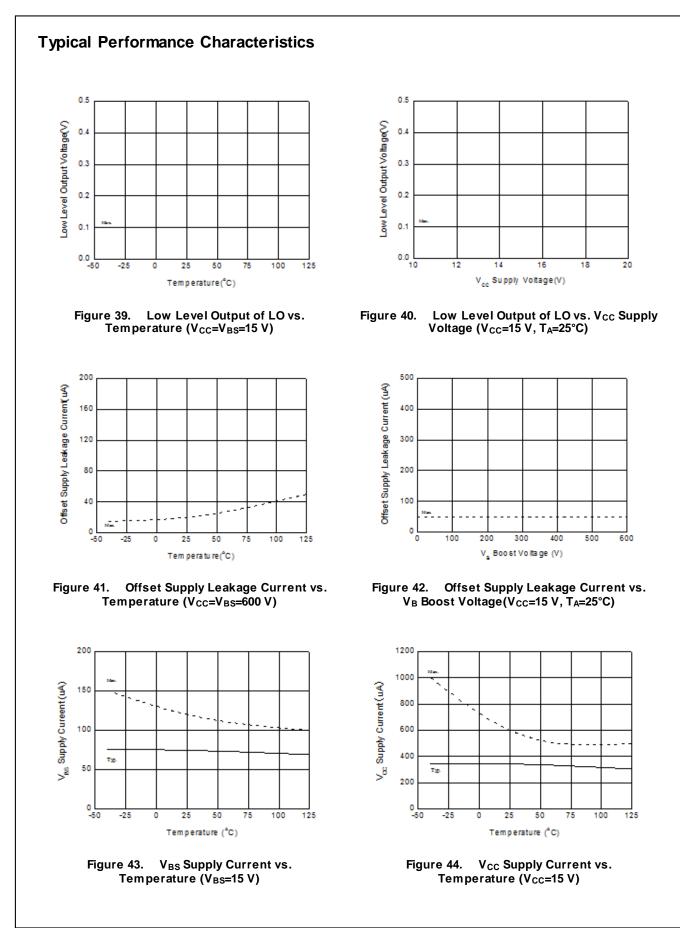
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Logic Low Input Voltage vs.

Temperature

Figure 31.





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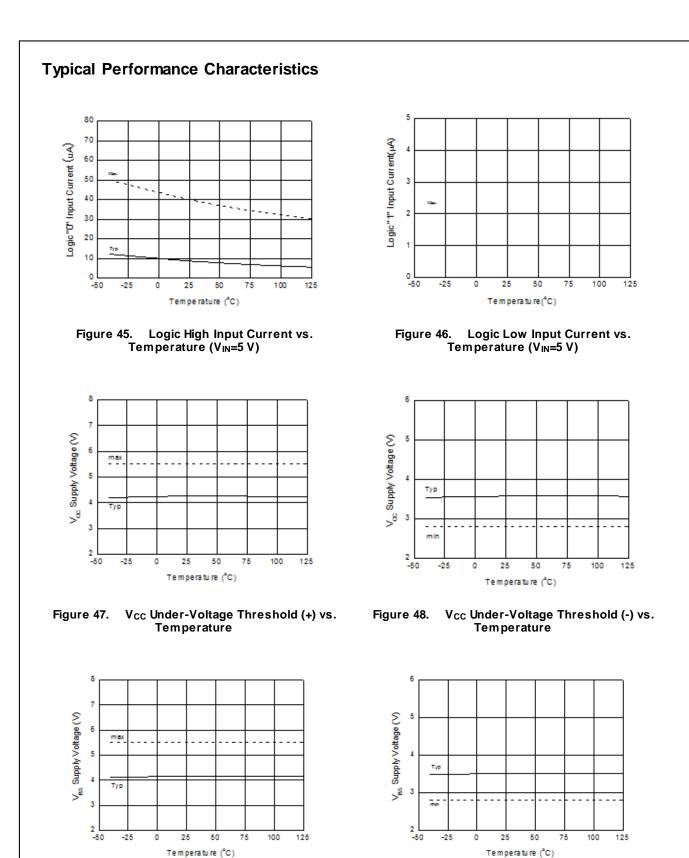
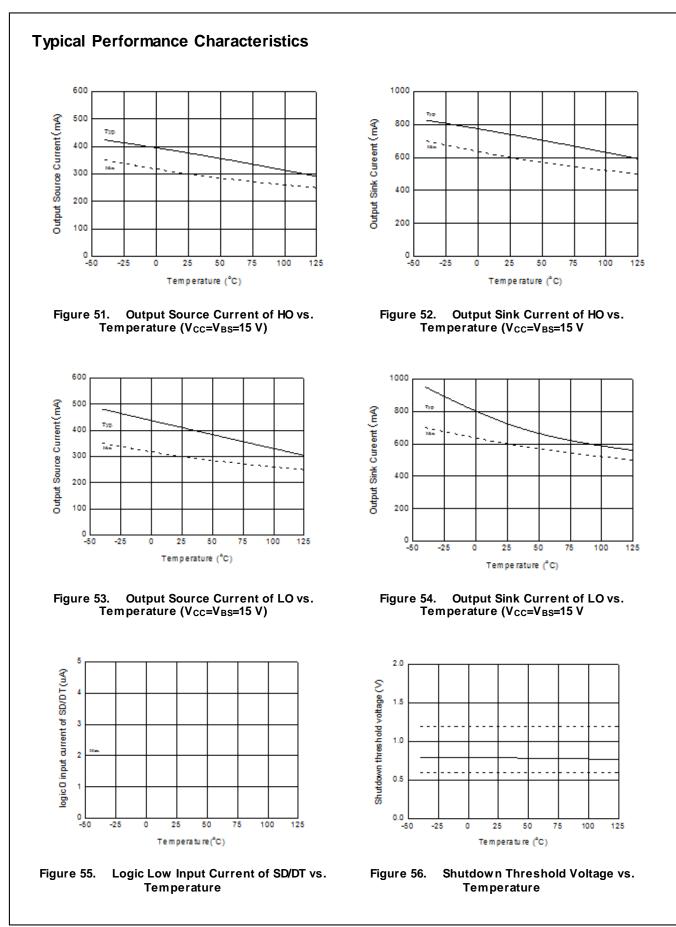


Figure 50. V_{BS} Under-Voltage Threshold (-) vs. Temperature

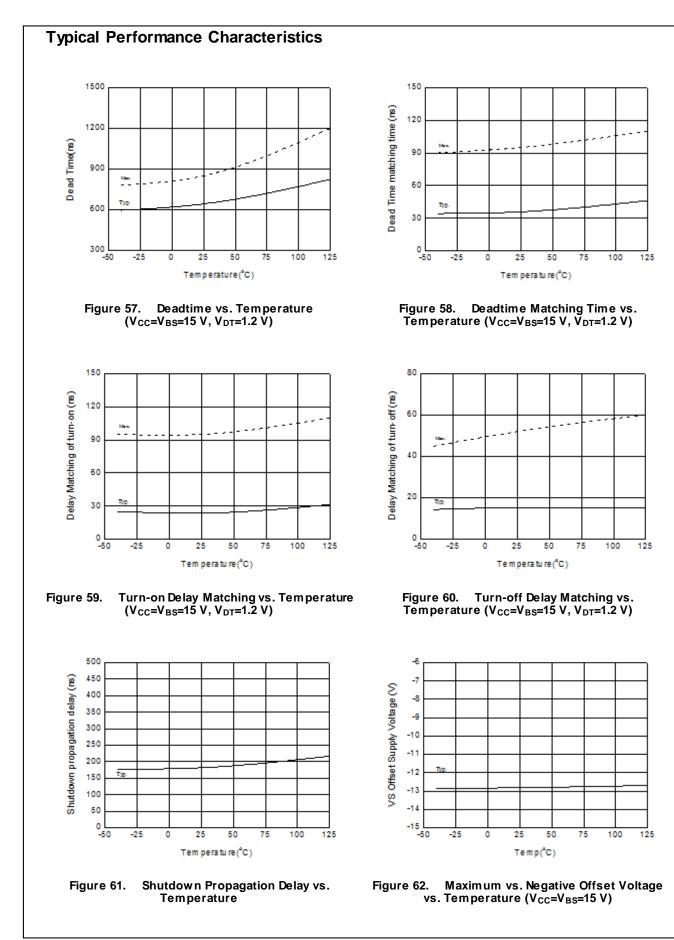
V_{BS} Under-Voltage Threshold (+) vs.

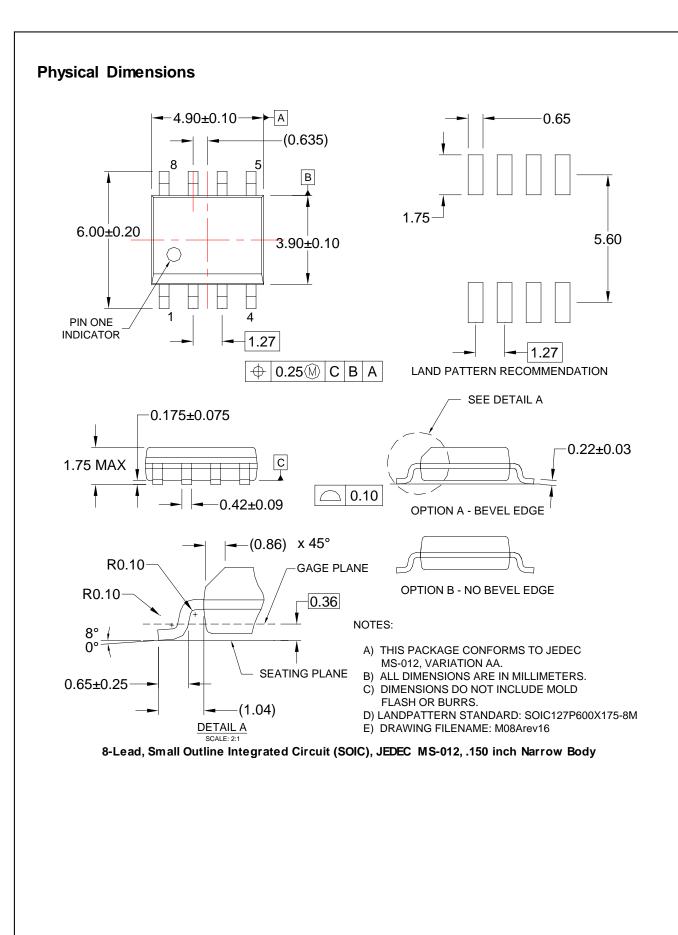
Temperature

Figure 49.



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